

## IGBT (NPT) Module

$$V_{CES} = 1200V$$

$$I_{C25} = 135A$$

$$V_{CE(sat)} = 2.2V$$


Buck Chopper + free wheeling Diode

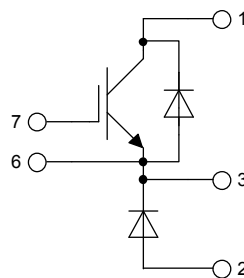
Part number

MDI100-12A3



Backside: isolated

 E72873



### Features / Advantages:

- NPT IGBT technology
- low saturation voltage
- low switching losses
- switching frequency up to 30 kHz
- square RBSOA, no latch up
- high short circuit capability
- positive temperature coefficient for easy parallelling
- MOS input, voltage controlled
- ultra fast free wheeling diodes

### Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

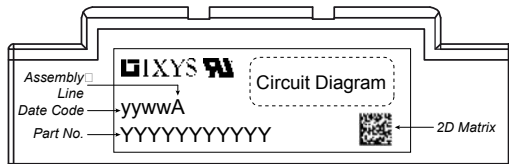
### Package: Y4

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

| Free Wheeling Diode FWD |  |   |                         | Ratings |      |            |
|-------------------------|--|---|-------------------------|---------|------|------------|
| Symbol                  | Definition                                   | Conditions                                | min.                    | typ.    | max. | Unit       |
| $V_{RSM}$               | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^{\circ}C$                    |                         |         | 1200 | V          |
| $V_{RRM}$               | max. repetitive reverse blocking voltage     | $T_{VJ} = 25^{\circ}C$                    |                         |         | 1200 | V          |
| $I_R$                   | reverse current, drain current               | $V_R = 1200 V$                            | $T_{VJ} = 25^{\circ}C$  |         | 1    | mA         |
|                         |  | $V_R = 1200 V$                            | $T_{VJ} = 125^{\circ}C$ |         | 3    | mA         |
| $V_F$                   | forward voltage drop                         | $I_F = 75 A$                              | $T_{VJ} = 25^{\circ}C$  |         | 2.50 | V          |
|                         |  |   |                         |         | 2.90 | V          |
|                         |  | $I_F = 150 A$                             | $T_{VJ} = 125^{\circ}C$ |         | 1.80 | V          |
|                         |  |   |                         |         | 2.10 | V          |
| $I_{FAV}$               | average forward current                      | $T_C = 80^{\circ}C$<br>DC current $d = 1$ | $T_{VJ} = 150^{\circ}C$ |         | 75   | A          |
|                         |  |   |                         |         |      |            |
| $V_{FO}$                | threshold voltage                            | } for power loss calculation only         | $T_{VJ} = 150^{\circ}C$ |         | 1.30 | V          |
| $r_F$                   | slope resistance                             |   |                         |         | 7.5  | m $\Omega$ |
| $R_{thJC}$              | thermal resistance junction to case          |   |                         |         | 0.45 | K/W        |
| $R_{thCH}$              | thermal resistance case to heatsink          |   |                         | 0.45    |      | K/W        |
| $P_{tot}$               | total power dissipation                      |   | $T_C = 25^{\circ}C$     |         | 280  | W          |
| $I_{FSM}$               | max. forward surge current                   | $t = 10 ms; (50 Hz), sine; V_R = 0 V$     | $T_{VJ} = 45^{\circ}C$  |         | 700  | A          |
| $C_J$                   | junction capacitance                         | $V_R = 600 V \quad f = 1 MHz$             | $T_{VJ} = 25^{\circ}C$  |         | 48   | pF         |

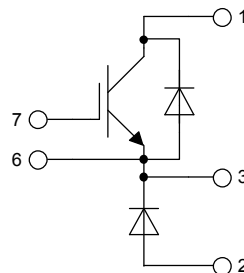
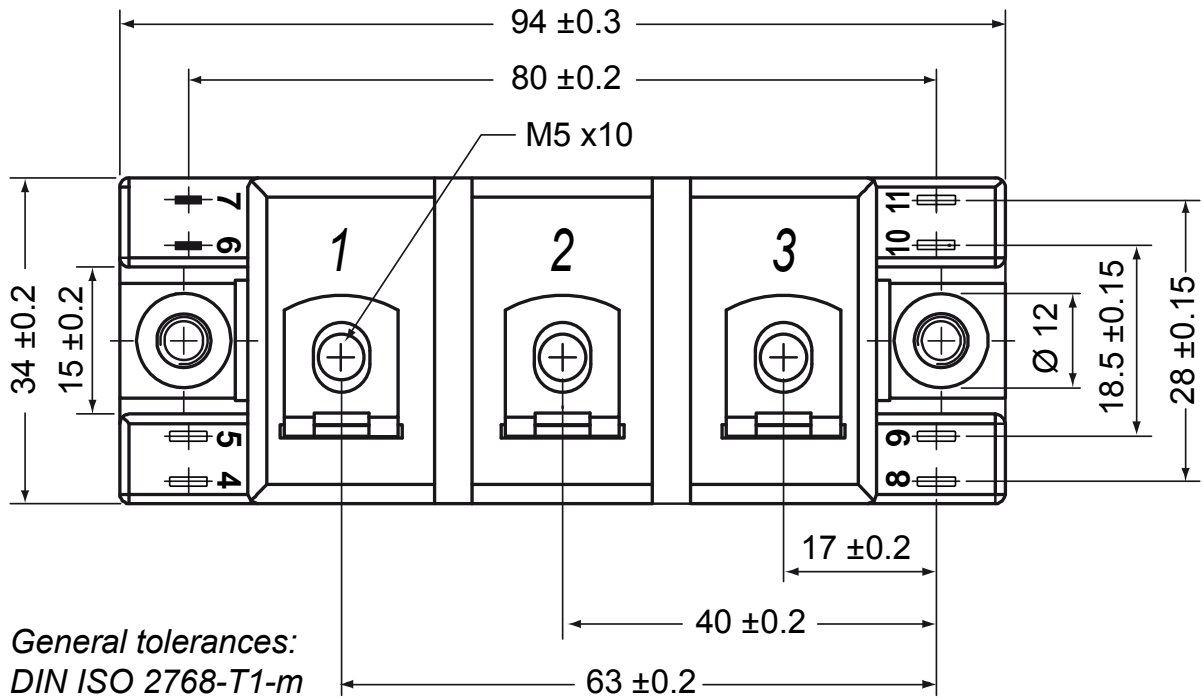
| Buck IGBT            |                                      |   |      | Ratings |          |               |  |
|----------------------|--------------------------------------|---|------|---------|----------|---------------|--|
| Symbol               | Definition                           | Conditions  | min. | typ.    | max.     | Unit          |  |
| $V_{CES}$            | collector emitter voltage            | $T_{VJ} = 25^{\circ}\text{C}$   |      |         | 1200     | V             |  |
| $V_{GES}$            | max. DC gate voltage                 |   |      |         | $\pm 20$ | V             |  |
| $V_{GEM}$            | max. transient gate emitter voltage  |   |      |         | $\pm 30$ | V             |  |
| $I_{C25}$            | collector current                    | $T_C = 25^{\circ}\text{C}$  |      |         | 135      | A             |  |
| $I_{C80}$            |                                      | $T_C = 80^{\circ}\text{C}$  |      |         | 90       | A             |  |
| $P_{tot}$            | total power dissipation              | $T_C = 25^{\circ}\text{C}$  |      |         | 560      | W             |  |
| $V_{CE(sat)}$        | collector emitter saturation voltage | $I_C = 75\text{A}; V_{GE} = 15\text{V}$   |      |         | 2.2      | V             |  |
|                      |                                      |   |      |         | 2.7      | V             |  |
| $V_{GE(th)}$         | gate emitter threshold voltage       | $I_C = 3\text{mA}; V_{GE} = V_{CE}$   | 4.5  | 5.5     | 6.5      | V             |  |
| $I_{CES}$            | collector emitter leakage current    | $V_{CE} = V_{CES}; V_{GE} = 0\text{V}$  |      |         | 5        | mA            |  |
|                      |                                      |   |      |         | 7.5      | mA            |  |
| $I_{GES}$            | gate emitter leakage current         | $V_{GE} = \pm 20\text{V}$   |      |         | 300      | nA            |  |
| $Q_{G(on)}$          | total gate charge                    | $V_{CE} = 600\text{V}; V_{GE} = 15\text{V}; I_C = 75\text{A}$   |      | 350     |          | nC            |  |
| $t_{d(on)}$          | turn-on delay time                   | inductive load<br>$V_{CE} = 600\text{V}; I_C = 75\text{A}$<br>$V_{GE} = \pm 15\text{V}; R_G = 15\Omega$ |      | 100     |          | ns            |  |
| $t_r$                | current rise time                    |   |      | 50      |          | ns            |  |
| $t_{d(off)}$         | turn-off delay time                  |   |      | 650     |          | ns            |  |
| $t_f$                | current fall time                    |   |      | 50      |          | ns            |  |
| $E_{on}$             | turn-on energy per pulse             |   |      | 12.1    |          | mJ            |  |
| $E_{off}$            | turn-off energy per pulse            |   |      | 10.5    |          | mJ            |  |
| <b>RBSOA</b>         | reverse bias safe operating area     | $V_{GE} = \pm 15\text{V}; R_G = 15\Omega$   |      |         |          |               |  |
| $I_{CM}$             |                                      | $V_{CEmax} = 1200\text{V}$  |      |         | 150      | A             |  |
| <b>SCSOA</b>         | short circuit safe operating area    | $V_{CEmax} = 1200\text{V}$  |      |         |          |               |  |
| $t_{sc}$             | short circuit duration               | $V_{CE} = 1200\text{V}; V_{GE} = \pm 15\text{V}$  |      |         | 10       | $\mu\text{s}$ |  |
| $I_{sc}$             | short circuit current                | $R_G = 15\Omega; \text{non-repetitive}$   |      | 270     |          | A             |  |
| $R_{thJC}$           | thermal resistance junction to case  |   |      |         | 0.22     | K/W           |  |
| $R_{thCH}$           | thermal resistance case to heatsink  |   |      |         | 0.22     | K/W           |  |
| <b>Buck Diode BD</b> |                                      |   |      |         |          |               |  |
| $V_{RRM}$            | max. repetitive reverse voltage      | $T_{VJ} = 25^{\circ}\text{C}$   |      |         | 1200     | V             |  |
| $I_{F25}$            | forward current                      | $T_C = 25^{\circ}\text{C}$  |      |         | 150      | A             |  |
| $I_{F80}$            |                                      | $T_C = 80^{\circ}\text{C}$  |      |         | 95       | A             |  |
| $V_F$                | forward voltage                      | $I_F = 75\text{A}$  |      |         | 2.50     | V             |  |
|                      |                                      |   |      |         | 1.70     | V             |  |
| $I_R$                | reverse current                      | $V_R = V_{RRM}$   |      |         | 1        | mA            |  |
|                      |                                      |   |      |         | 1.5      | mA            |  |
| $Q_{rr}$             | reverse recovery charge              | $V_R = 600\text{V}$<br>$-di_F/dt = 600\text{A}/\mu\text{s}$<br>$I_F = 75\text{A}; V_{GE} = 0\text{V}$   |      | 7       |          | $\mu\text{C}$ |  |
| $I_{RM}$             | max. reverse recovery current        |   |      | 62      |          | A             |  |
| $t_{rr}$             | reverse recovery time                |   |      | 200     |          | ns            |  |
| $E_{rec}$            | reverse recovery energy              |   |      | 1.2     |          | mJ            |  |
| $R_{thJC}$           | thermal resistance junction to case  |   |      |         | 0.45     | K/W           |  |
| $R_{thCH}$           | thermal resistance case to heatsink  |   |      |         | 0.45     | K/W           |  |

| Package Y4     |  |                      |                                     | Ratings |      |      |
|----------------|--|----------------------|-------------------------------------|---------|------|------|
| Symbol         | Definition   | Conditions           | min.                                | typ.    | max. | Unit |
| $I_{RMS}$      | RMS current  | per terminal         |                                     |         | 300  | A    |
| $T_{VJ}$       | virtual junction temperature                                 |                      | -40                                 |         | 150  | °C   |
| $T_{op}$       | operation temperature  |                      | -40                                 |         | 125  | °C   |
| $T_{stg}$      | storage temperature  |                      | -40                                 |         | 125  | °C   |
| <b>Weight</b>  |  |                      |                                     |         | 108  | g    |
| $M_D$          | mounting torque  |                      | 2.25                                |         | 2.75 | Nm   |
| $M_T$          | terminal torque  |                      | 4.5                                 |         | 5.5  | Nm   |
| $d_{Sppl/App}$ | creepage distance on surface   striking distance through air | terminal to terminal | 14.0                                | 10.0    |      | mm   |
| $d_{Spb/Apb}$  |  | terminal to backside | 16.0                                | 16.0    |      | mm   |
| $V_{ISOL}$     | isolation voltage  | t = 1 second         |                                     |         | 3600 | V    |
|                |  | t = 1 minute         | 50/60 Hz, RMS; $I_{ISOL} \leq 1$ mA |         | 3000 | V    |



| Ordering | Part Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-------------|--------------------|---------------|----------|----------|
| Standard | MDI100-12A3 | MDI100-12A3        | Box           | 6        | 466824   |

## Outlines Y4



## Buck IGBT

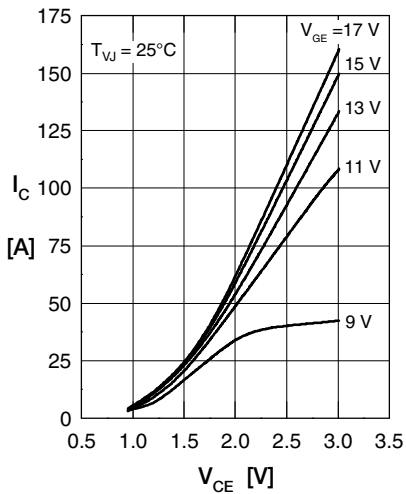


Fig. 1 Typ. output characteristics

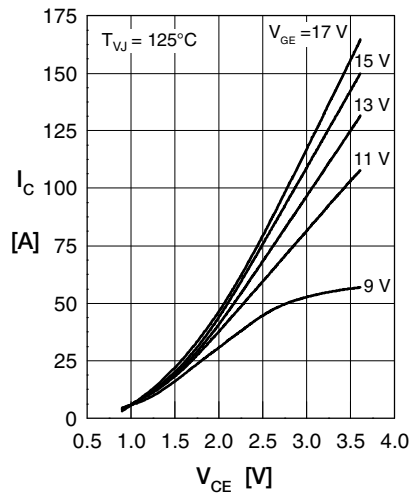


Fig. 2 Typ. output characteristics

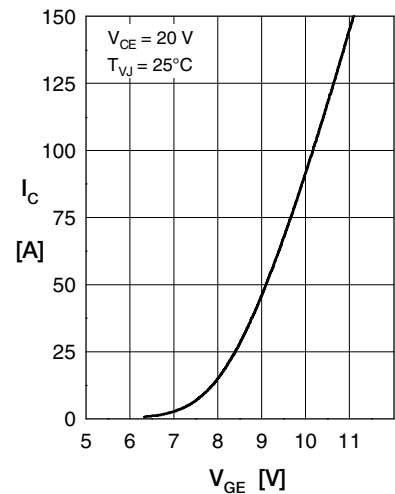


Fig. 3 Typ. transfer characteristics

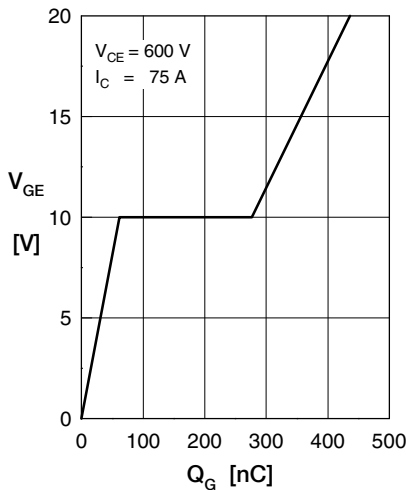


Fig. 4 Typ. turn-on gate charge

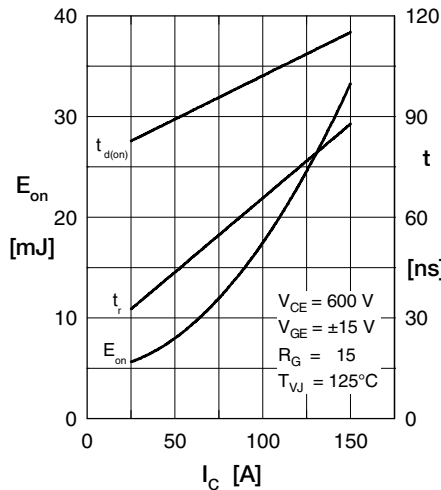


Fig. 5 Typ. turn on energy & switching times versus collector current

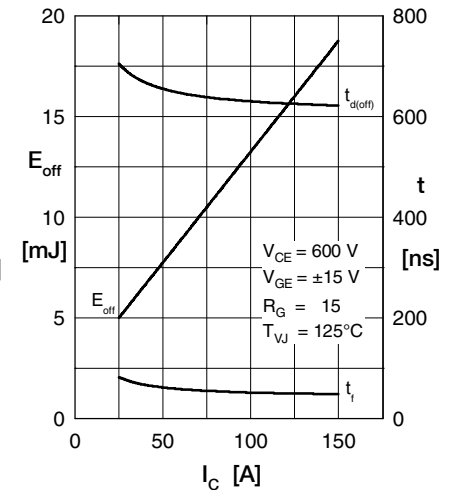


Fig. 6 Typ. turn off energy & switching times versus collector current

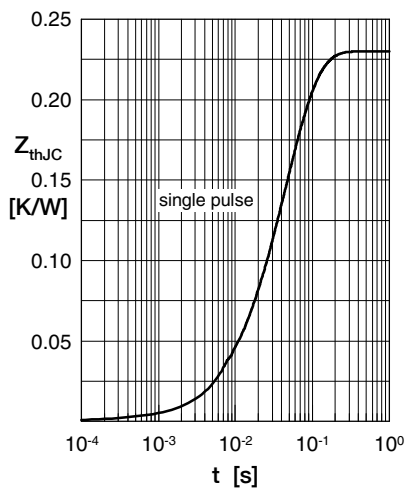


Fig. 12 Typical transient thermal impedance

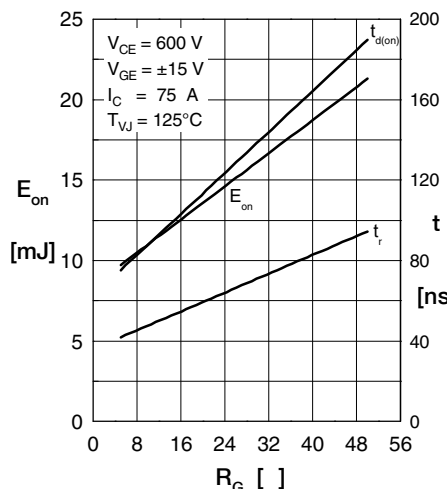


Fig. 9 Typ. turn on energy & switching times versus gate resistor

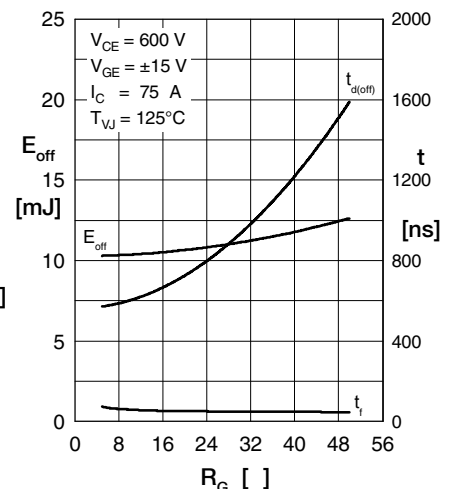


Fig. 9 Typ. turn off energy & switching times versus gate resistor

**Buck Diode BD**

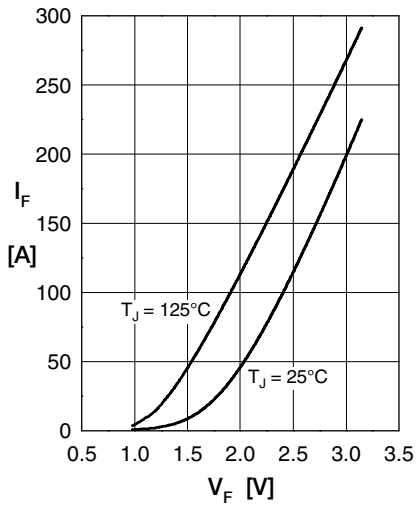


Fig. 1 Typ. Forward current vs.  $V_F$

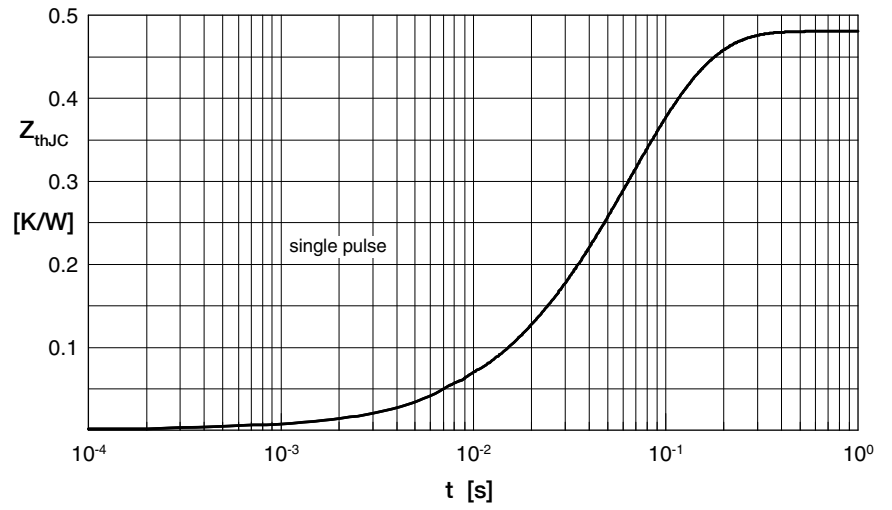


Fig. 2 Typ. transient thermal impedance junction to case